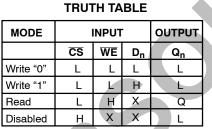
16 x 4 Bit Register File (RAM)

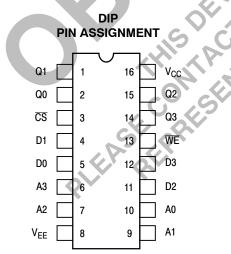
The MC10H145 is a 16 x 4 bit register file. The active-low chip select allows easy expansion.

The operating mode of the register file is controlled by the \overline{WE} input. When \overline{WE} is "low" the device is in the write mode, the outputs are "low" and the data present at D_n input is stored at the selected address, when \overline{WE} is "high," the device is in the read mode – the data state at the selected location is present at the Q_n outputs.

- Address Access Time, 4.5 ns Typical
- Power Dissipation, 700 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K-Compatible



Q-State of Addressed Cell

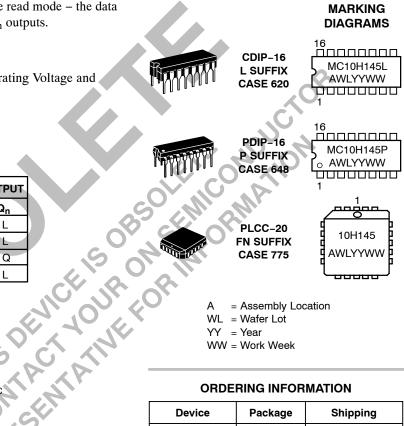


Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6-11 of the Motorola MECL Data Book (DL122/D).



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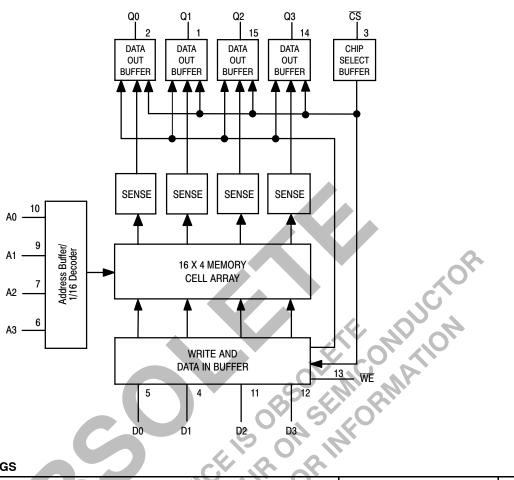


= Assembly Location Α WL = Wafer Lot YY = Year WW = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC10H145L	CDIP-16	25 Units/Rail
MC10H145P	PDIP-16	25 Units/Rail
MC10H145FN	PLCC-20	xx Units/Rail





MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply (V _{CC} = 0)	–8.0 to 0	Vdc
VI	Input Voltage (V _{CC} = 0)	0 to V _{EE}	Vdc
l _{out}	Output Current - Continuous - Surge	50 100	mA
T _A	Operating Temperature Range	0 to +75	°C
T _{stg}	Storage Temperature Range – Plastic – Ceramic	–55 to +150 −55 to +165	°C

ELECTRICAL CHARACTERISTICS (V_{EE} = -5.2 V ±5%) (See Note)

Symbol	Characteristic	0 °		25°		75 °		
		Min	Max	Min	Max	Min	Max	Unit
١ _E	Power Supply Current	-	160	-	163	-	165	mA
I _{inH}	Input Current High	-	375	-	220	-	220	μA
l _{inL}	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V _{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V _{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
VIH	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V _{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

 Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts.

AC PARAMETERS

		MC10H145 T _A = 0 to +75°C, V _{EE} = -5.2 Vdc ±5%			
Symbol	Characteristics	Min	Max	Unit	Conditions
t _{ACS} t _{RCS} t _{AA}	Read Mode Chip Select Access Time Chip Select Recovery Time Address Access Time	0 0 0	4.0 4.0 6.0	ns	Measured from 50% of input to 50% of output. See Note 2.
tw twsd twhd twsa twha twscs twhcs tws twr	Write Mode Write Pulse Width Data Setup Time Prior to Write Data Hold Time After Write Address Setup Time Prior to Write Address Hold Time After Write Chip Select Setup Time Prior to Write Chip Select Hold Time After Write Write Disable Time Write Recovery Time	6.0 0 1.5 3.5 1.5 0 1.5 1.0 1.0	- - - 4.0 4.0	ns	t _{WSA} = 3.5 ns Measured at 50% of input to 50% of output. t _W = 6.0 ns.
tcsd tcsw tcsa tchd tchw tcha tcs	Chip Enable Strobe Mode Data Setup Prior to Chip Select Write Enable Setup Prior to Chip Select Address Setup Prior to Chip Select Data Hold Time After Chip Select Write Enable Hold Time After Chip Select Address Hold Time After Chip Select Chip Select Minimum Pulse Width	0 0 0 1.0 0 2.0 4.0		ns	Guaranteed but not tested on standard product. See Figure 1.
t _r , t _f	Rise and Fall Time Address to Output CS to Output	0.6 0.6	2.5 2.5	ns	Measured between 20% and 80% points.
C _{in} C _{out}	Capacitance Input Capacitance Output Capacitance	K-S	6.0 8.0	pF	Measured with a pulse technique.

NOTES:

1. Test circuit characteristics: $R_T = 50 \Omega$, MC10H145. $C_L \le 5.0 \text{ pF}$ (including jig and Stray Capacitance). Delay should be derated 30 ps/pF

for capacitive loads up to 50 pF.

- 2. The maximum Address Access Time is guaranteed to be the worst-case bit in the memory.
- 3. For proper use of MECL in a system environment, consult MECL System Design Handbook.

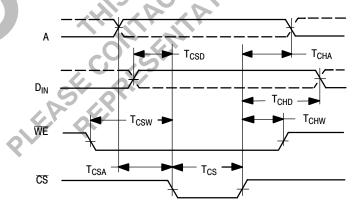
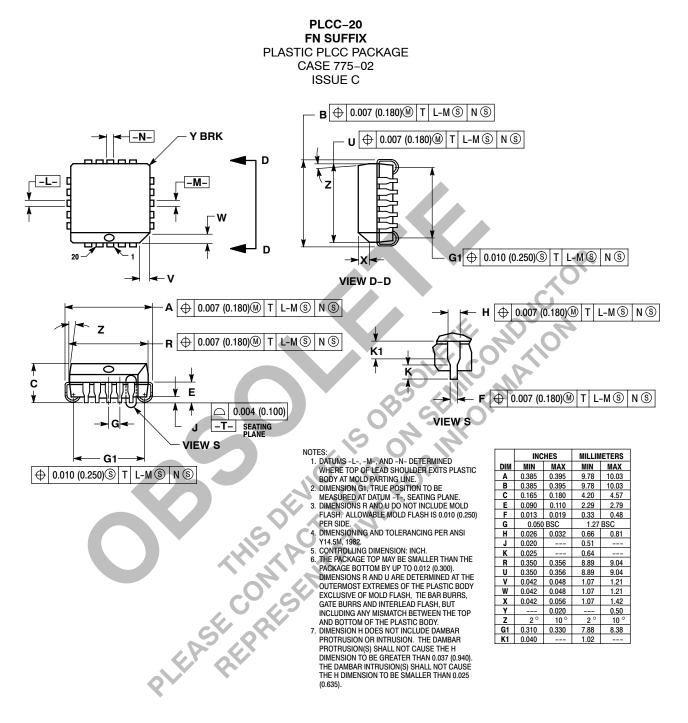
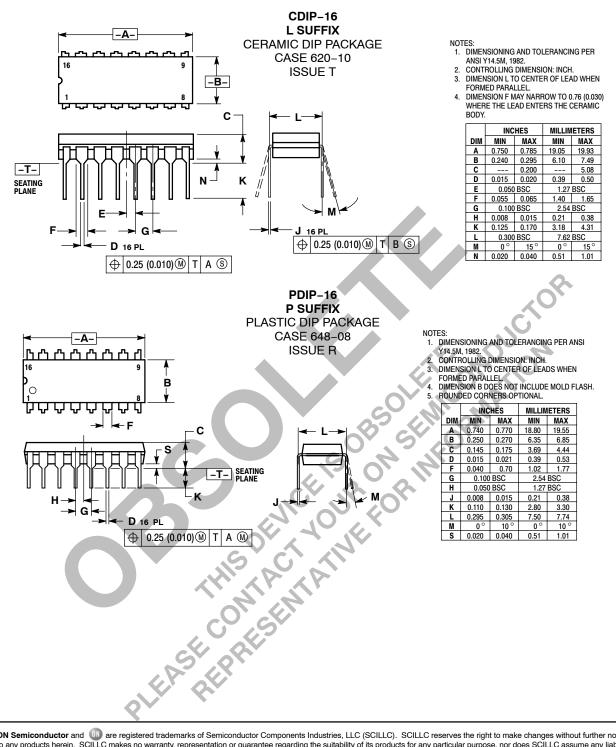


Figure 1. Chip Enable Strobe Mode

PACKAGE DIMENSIONS





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